

International **IR** Rectifier

PD-90426D

**REPETITIVE AVALANCHE AND dv/dt RATED
HEXFET® TRANSISTORS
THRU-HOLE (TO-205AF)**

**IRFF120
JANTX2N6788
JANTXV2N6788
REF:MIL-PRF-19500/555
100V, N-CHANNEL**

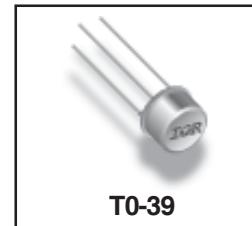
Product Summary

Part Number	Bvdss	Rds(on)	Id
IRFF120	100V	0.30Ω	6.0A

The HEXFET® technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry and unique processing of this latest "State of the Art" design achieves: very low on-state resistance combined with high transconductance.

The HEXFET transistors also feature all of the well established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling and temperature stability of the electrical parameters.

They are well suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits.



Features:

- Repetitive Avalanche Ratings
- Dynamic dv/dt Rating
- Hermetically Sealed
- Simple Drive Requirements
- Ease of Paralleling

Absolute Maximum Ratings

	Parameter		Units
Id @ VGS = 10V, TC = 25°C	Continuous Drain Current	6.0	A
Id @ VGS = 10V, TC = 100°C	Continuous Drain Current	3.5	
Idm	Pulsed Drain Current ①	24	
PD @ TC = 25°C	Max. Power Dissipation	20	W
	Linear Derating Factor	0.16	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	0.242	mJ
IAR	Avalanche Current ①	2.2	A
EAR	Repetitive Avalanche Energy ①	2.0	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.5	V/ns
TJ	Operating Junction	-55 to 150	°C
TSTG	Storage Temperature Range		
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10s)	
	Weight	0.98 (typical)	g

For footnotes refer to the last page

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09/03/07

Electrical Characteristics @ $T_j = 25^\circ\text{C}$ (Unless Otherwise Specified)

	Parameter	Min	Typ	Max	Units	Test Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	100	—	—	V	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = 1.0\text{mA}$
$\Delta \text{BV}_{\text{DSS}/\Delta T_J}$	Temperature Coefficient of Breakdown Voltage	—	0.10	—	V°C	Reference to 25°C , $\text{I}_D = 1.0\text{mA}$
$R_{\text{DS(on)}}$	Static Drain-to-Source On-State Resistance	—	—	0.30	Ω	$\text{V}_{\text{GS}} = 10\text{V}, \text{I}_D = 3.5\text{A}$ ④
		—	—	0.35		$\text{V}_{\text{GS}} = 10\text{V}, \text{I}_D = 6.0\text{A}$ ④
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	2.0	—	4.0	V	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = 250\mu\text{A}$
g_{fs}	Forward Transconductance	1.5	—	—	S	$\text{V}_{\text{DS}} > 15\text{V}, \text{I}_{\text{DS}} = 3.5\text{A}$ ④
I_{DSS}	Zero Gate Voltage Drain Current	—	—	25	μA	$\text{V}_{\text{DS}} = 80\text{V}, \text{V}_{\text{GS}} = 0\text{V}$
		—	—	250		$\text{V}_{\text{DS}} = 80\text{V}$ $\text{V}_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Leakage Forward	—	—	100	nA	$\text{V}_{\text{GS}} = 20\text{V}$
I_{GSS}	Gate-to-Source Leakage Reverse	—	—	-100		$\text{V}_{\text{GS}} = -20\text{V}$
Q_g	Total Gate Charge	7.7	—	18	nC	$\text{V}_{\text{GS}} = 10\text{V}, \text{I}_D = 6.0\text{A}$
Q_{gs}	Gate-to-Source Charge	0.7	—	4.0		$\text{V}_{\text{DS}} = 50\text{V}$
Q_{gd}	Gate-to-Drain ('Miller') Charge	2.0	—	9.0		
$t_{\text{d(on)}}$	Turn-On Delay Time	—	—	40	ns	$\text{V}_{\text{DD}} = 35\text{V}, \text{I}_D = 6.0\text{A}, \text{V}_{\text{GS}} = 10\text{V}, R_G = 7.5\Omega$
t_r	Rise Time	—	—	70		
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	—	40		
t_f	Fall Time	—	—	70		
$L_S + L_D$	Total Inductance	—	7.0	—	nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
C_{iss}	Input Capacitance	—	350	—	pF	$\text{V}_{\text{GS}} = 0\text{V}, \text{V}_{\text{DS}} = 25\text{V}$ $f = 1.0\text{MHz}$
C_{oss}	Output Capacitance	—	150	—		
C_{rss}	Reverse Transfer Capacitance	—	24	—		

Source-Drain Diode Ratings and Characteristics

	Parameter	Min	Typ	Max	Units	Test Conditions
I_S	Continuous Source Current (Body Diode)	—	—	6.0	A	$T_j = 25^\circ\text{C}, I_S = 6.0\text{A}, V_{\text{GS}} = 0\text{V}$ ④
I_{SM}	Pulse Source Current (Body Diode)	—	—	24		
V_{SD}	Diode Forward Voltage	—	—	1.8	V	
t_{rr}	Reverse Recovery Time	—	—	240	ns	$T_j = 25^\circ\text{C}, I_F = 6.0\text{A}, dI/dt \leq 100\text{A}/\mu\text{s}$ $V_{\text{DD}} \leq 50\text{V}$ ④
Q_{RR}	Reverse Recovery Charge	—	—	2.0	μC	
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$.				

Thermal Resistance

	Parameter	Min	Typ	Max	Units	Test Conditions
R_{thJC}	Junction-to-Case	—	—	6.25	$^\circ\text{C}/\text{W}$	
R_{thJA}	Junction-to-Ambient	—	—	175	$^\circ\text{C}/\text{W}$	Typical socket mount.

Note: Corresponding Spice and Saber models are available on International Rectifier Website.

For footnotes refer to the last page

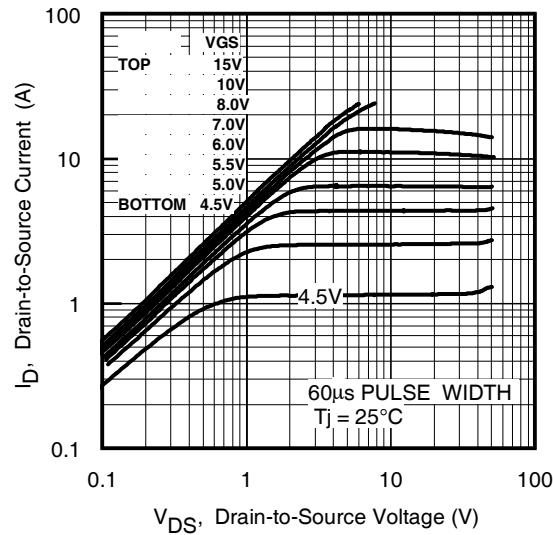


Fig 1. Typical Output Characteristics

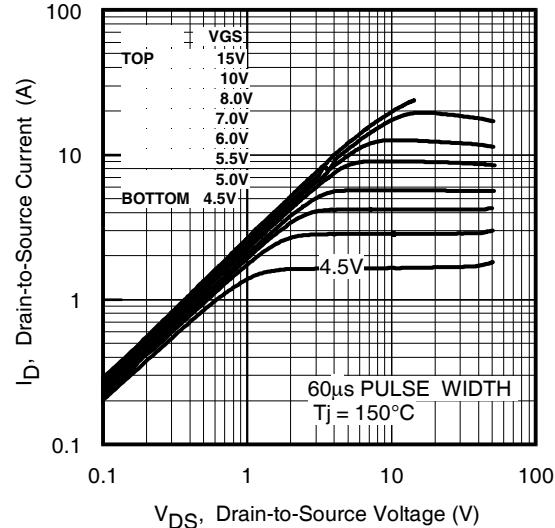


Fig 2. Typical Output Characteristics

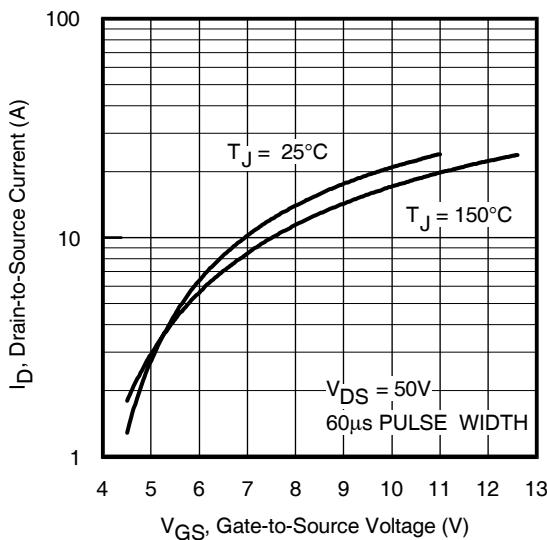


Fig 3. Typical Transfer Characteristics

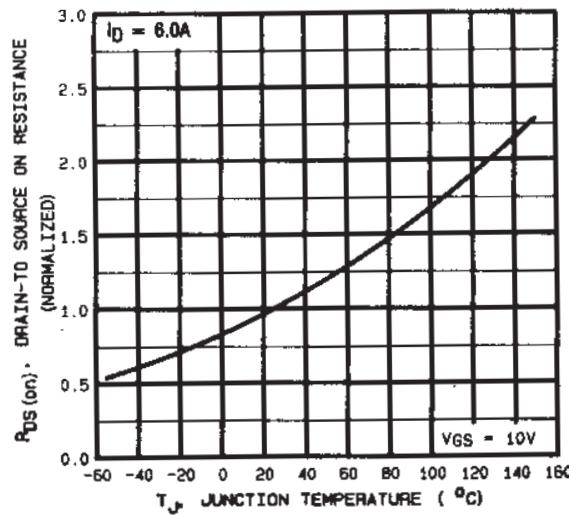


Fig 4. Normalized On-Resistance Vs. Temperature

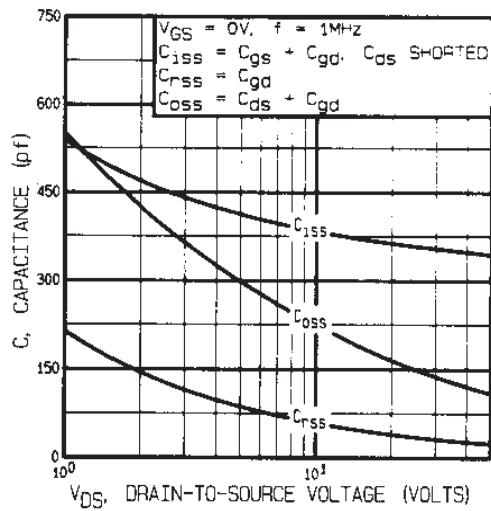


Fig5. Typical Capacitance Vs.
Drain-to-Source Voltage

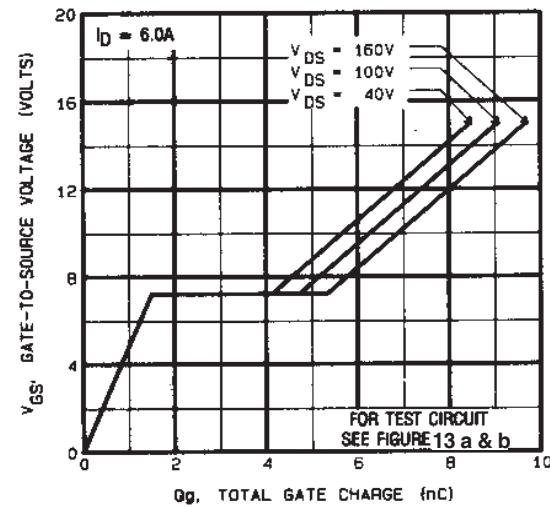


Fig6. Typical Gate Charge Vs.
Gate-to-Source Voltage

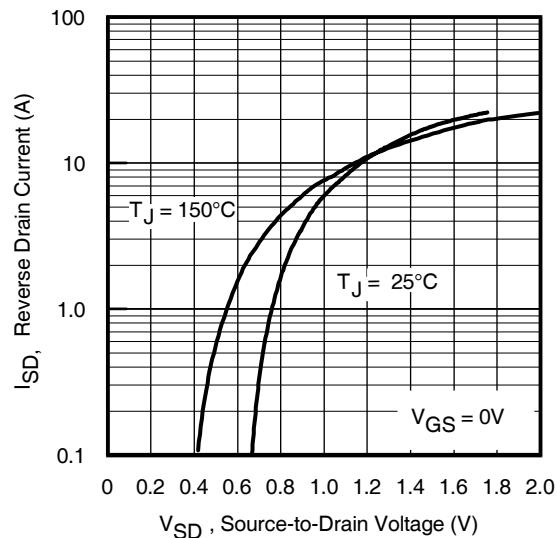


Fig7. Typical Source-Drain Diode
Forward Voltage

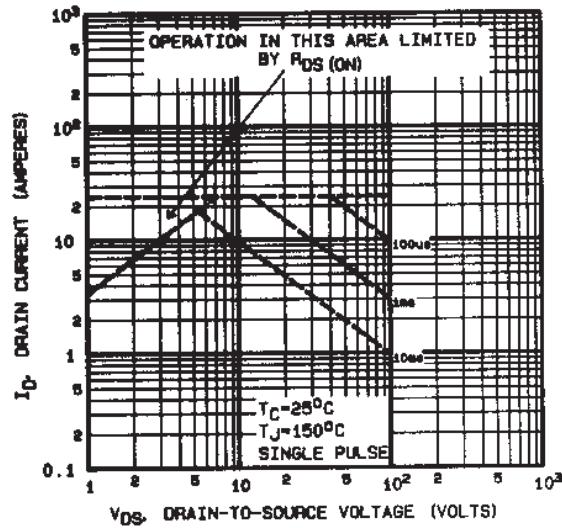


Fig8. Maximum Safe Operating Area

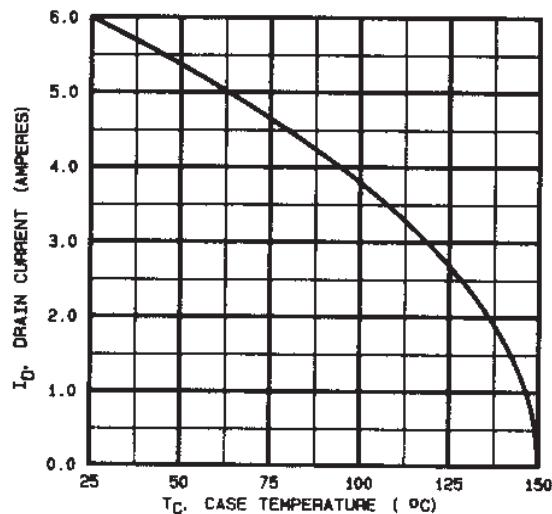


Fig 9. Maximum Drain Current Vs.
Case Temperature

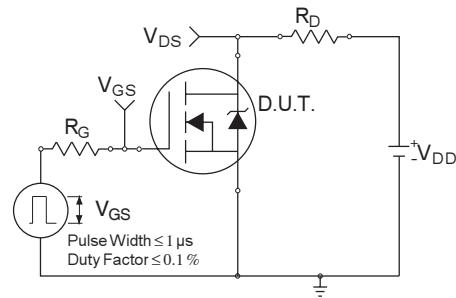


Fig 10a. Switching Time Test Circuit

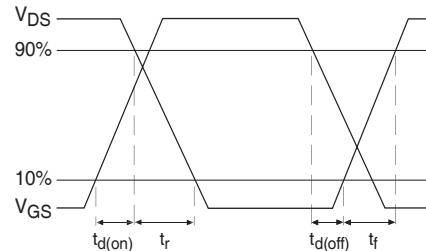


Fig 10b. Switching Time Waveforms

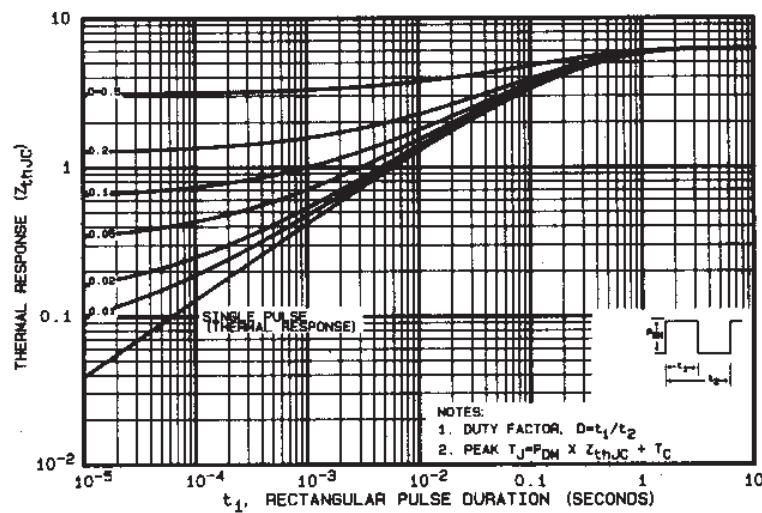


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

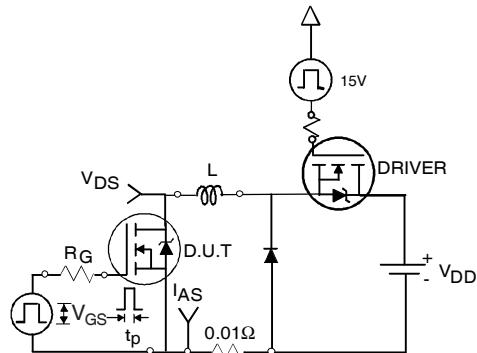


Fig 12a. Unclamped Inductive Test Circuit

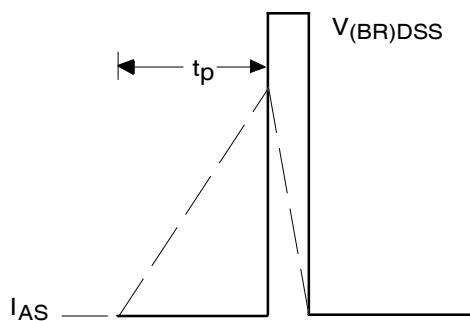


Fig 12b. Unclamped Inductive Waveforms

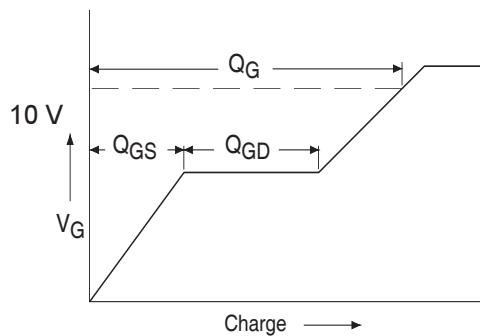


Fig 13a. Basic Gate Charge Waveform

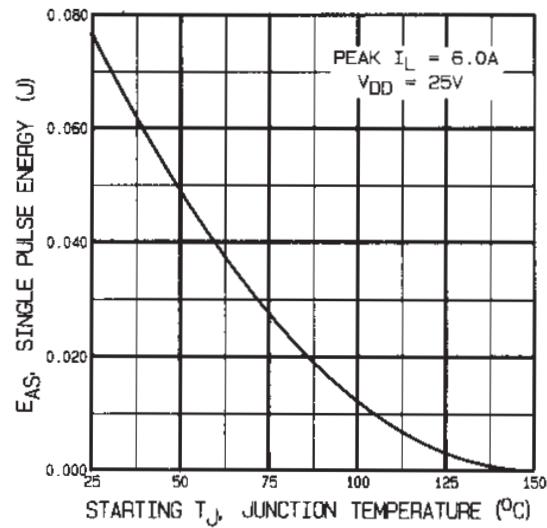


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

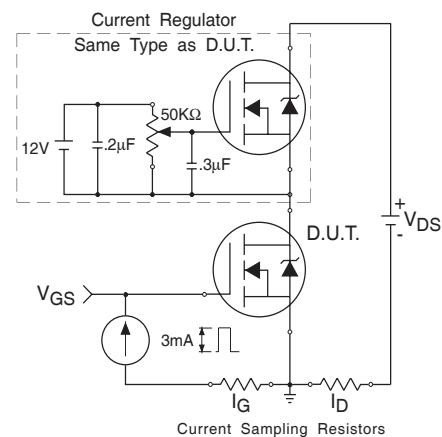
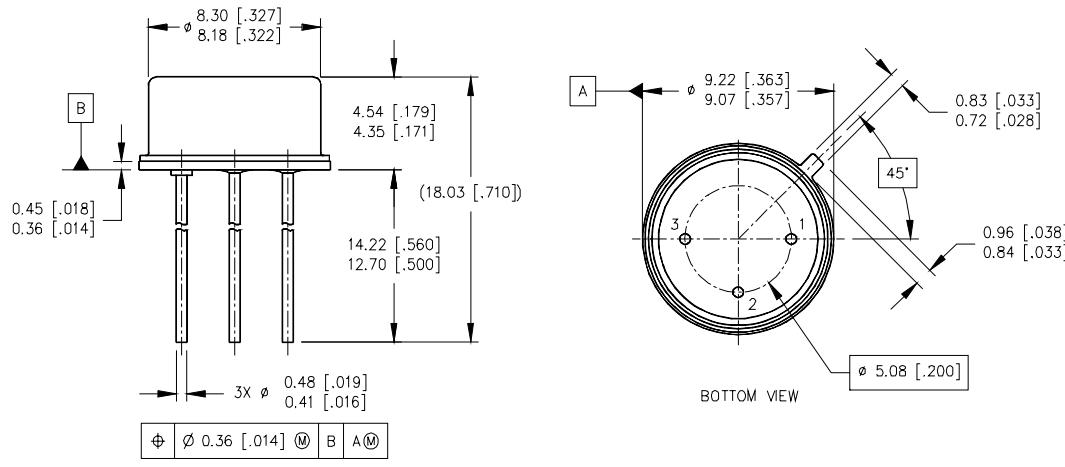


Fig 13b. Gate Charge Test Circuit

Foot Notes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② $V_{DD} = 25V$, starting $T_J = 25^\circ C$, Peak $I_L = 2.2A$, $L = 100\mu H$
- ③ $I_{SD} \leq 6.0A$, $dI/dt \leq 110A/\mu s$, $V_{DD} \leq 100V$, $T_J \leq 150^\circ C$
Suggested $R_G = 7.5 \Omega$
- ④ Pulse width $\leq 300 \mu s$; Duty Cycle $\leq 2\%$

Case Outline and Dimensions — TO-205AF(Modified TO-39)



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME 14.5M-1994.
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3. CONTROLLING DIMENSION: INCH.
4. CONFORMS TO JEDEC OUTLINE TO-205AF (TO-39).

LEGEND
 1- SOURCE
 2- GATE
 3- DRAIN

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Data and specifications subject to change without notice. 09/2007